## IN THE CLAIMS

Claim 1-19 (Cancelled).

- 20 (Currently Amended). An integrated circuit comprising:
  - a semiconductor structure;
  - a gate formed on said semiconductor structure; and
- a <u>P-type</u> source and a <u>P-type</u> drain region, said source and drain region including both germanium and a P-type <u>source/drain</u> impurity, said source and drain <u>regions</u> region being strained.
- 21 (Currently Amended). The circuit of claim 20 wherein the ratio of germanium to P-type source/drain impurity impurities is greater than one to one.
- 22 (Currently Amended). The circuit of claim 20 wherein the ratio of germanium to P-type source/drain impurity impurities is approximately four to one.
- 23 (Currently Amended). The circuit of claim 20 wherein said <u>source and drain</u> regions are source and <u>drain extensions</u>. P-type impurities are boron impurities.
- 24 (Original). The circuit of claim 20 wherein said source/drain region that includes both boron and germanium is a source/drain extension.